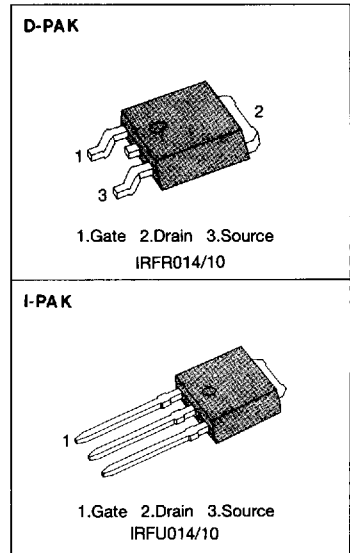


FEATURES

- Lower $R_{DS(on)}$
- Improved inductive ruggedness
- Fast switching times
- Rugged polysilicon gate cell structure
- Lower input capacitance
- Extended safe operating area
- Improved high temperature reliability

PRODUCT SUMMARY

Part Number	V _{DS}	R _{DS(on)}	I _D
IRFR014/U014	60V	0.20 Ω	8.2A
IRFR010/U010	50V	0.20 Ω	8.2A



ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	IRFR014/U014	IRFR010/U010	Unit
Drain-Source Voltage (1)	V _{DS}	60	50	Vdc
Drain-Gate Voltage (R _{GS} =1.0M Ω)(1)	V _{DGR}	60	50	Vdc
Gate-Source Voltage	V _{GS}	± 20		Vdc
Continuous Drain Current T _C =25 °C	I _D	8.2		Adc
Continuous Drain Current T _C =100 °C	I _D	5.2		Adc
Drain Current - Pulsed (3)	I _{DM}	33		Adc
Gate Current - Pulsed	I _{GM}	± 1.5		Adc
Single Pulsed Avalanche Energy (4)	E _{AS}	1.4		mJ
Avalanche Current	I _{AS}	8.2		A
Total Power Dissipation at T _C =25 °C	P _D	25		Watts
Derate above 25 °C		0.20		W/ °C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150		°C
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	T _L	300		°C

- Notes : (1) T_J=25 °C to 150 °C
 (2) Pulse test : Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$
 (3) Repetitive rating : Pulse width limited by max. junction temperature
 (4) L=50 μH , V_{dd}=25V, R_G=25 Ω , Starting T_J=25 °C

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ELECTRICAL CHARACTERISTICS (Tc=25°C unless otherwise specified)

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
BV _{DSS}	Drain-Source Breakdown Voltage					
	IRFR014/U014	60	-	-	V	V _{GS} =0V, I _D =250μA
	IRFR010/U010	50	-	-	V	
V _{GS(th)}	Gate Threshold Voltage	2.0	-	4.0	V	V _D =V _{GS} , I _D =250μA
I _{GSS}	Gate-Source Leakage Forward	-	-	100	nA	V _{GS} =20V
I _{GSS}	Gate-Source Leakage Reverse	-	-	-100	nA	V _{GS} =-20V
I _{DSS}	Zero Gate Voltage Drain Current	-	-	250	μA	V _D =Max. Rating, V _{GS} =0V
		-	-	1000	μA	V _D =0.8 Max. Rating, V _{GS} =0V, T _C =125°C
R _{DS(on)}	Static Drain-Source on Resistance(2)	-	-	0.20	Ω	V _{GS} =10V, I _D =4.1A
g _{fs}	Forward Transconductance (2)	2.1	-	-	Ω	V _D ≥50V, I _D =4.1A
C _{iss}	Input Capacitance	-	358	-	pF	V _{GS} =0V
C _{oss}	Output Capacitance	-	134	-	pF	V _D =25V
C _{rss}	Reverse Transfer Capacitance	-	55	-	pF	f=1.0MHz
t _{d(on)}	Turn-On Delay Time	-	-	17	ns	V _D =0.5 BV _{DSS} , I _D =8.2A, Z _θ =24 Ω (MOSFET switching times are essentially independent of operating temperature)
t _r	Rise Time	-	-	50	ns	
t _{d(off)}	Turn-Off Delay Time	-	-	18	ns	
t _f	Fall Time	-	-	35	ns	
Q _g	Total Gate Charge (Gate-Source Plus Gate-Drain)	-	-	13.0	nC	V _{GS} =10V, I _D =8.2A, V _D =0.8 Max. Rating (Gate charge is essentially independent of operating temperature)
Q _{gs}	Gate-Source Charge	-	3.8	-	nC	
Q _{gd}	Gate-Drain ("Miller") Charge	-	4.8	-	nC	

THERMAL RESISTANCE

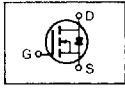
Symbol	Characteristics		All	Units	Remark
R _{thJC}	Junction-to-Case	MAX	5.0	K/W	
R _{thCS}	Case-to-Sink	TYP	1.7	K/W	Mounting surface flat, smooth and greased
R _{thJA}	Junction-to-Ambient	MAX	110	K/W	Free Air Operation

Notes : (1) T_J=25°C to 150°C

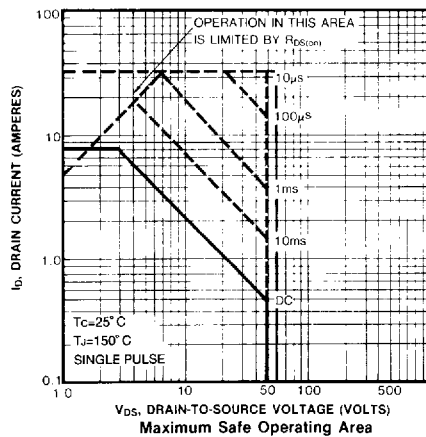
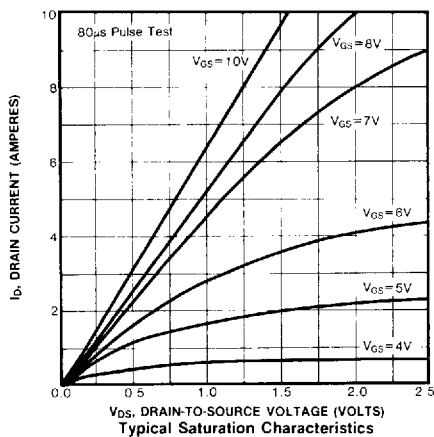
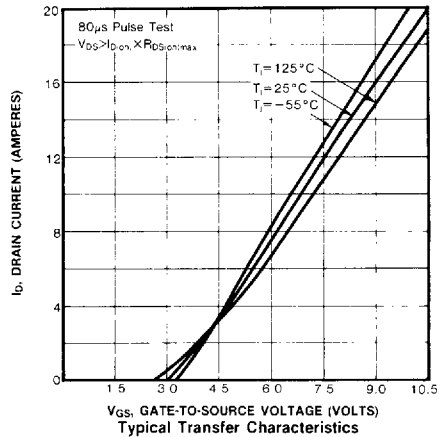
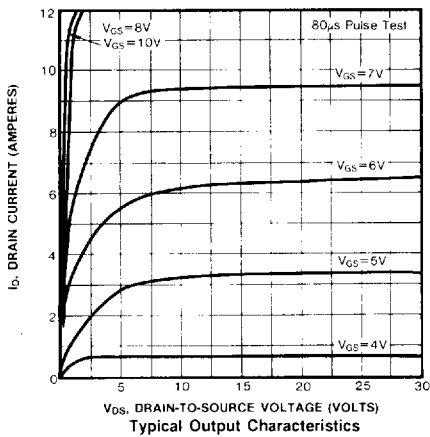
(2) Pulse test : Pulse width ≤300μs, Duty Cycle ≤2%

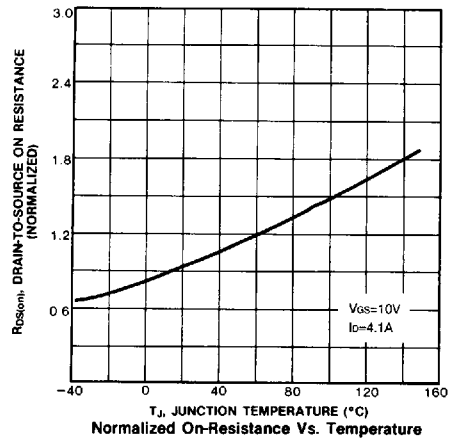
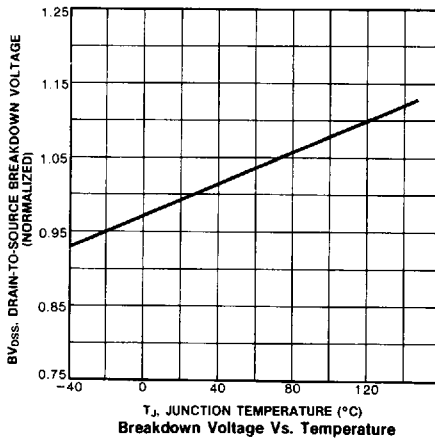
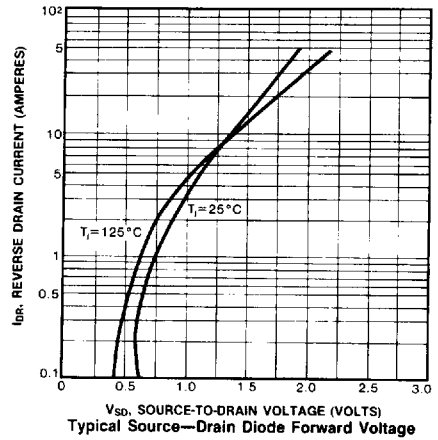
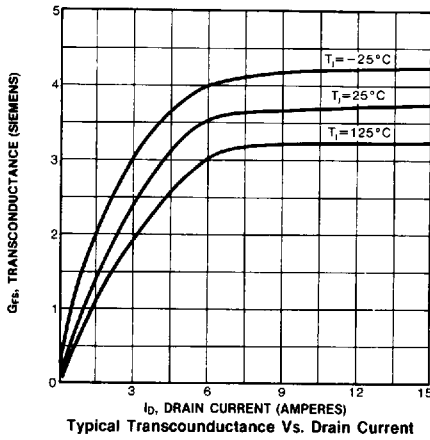
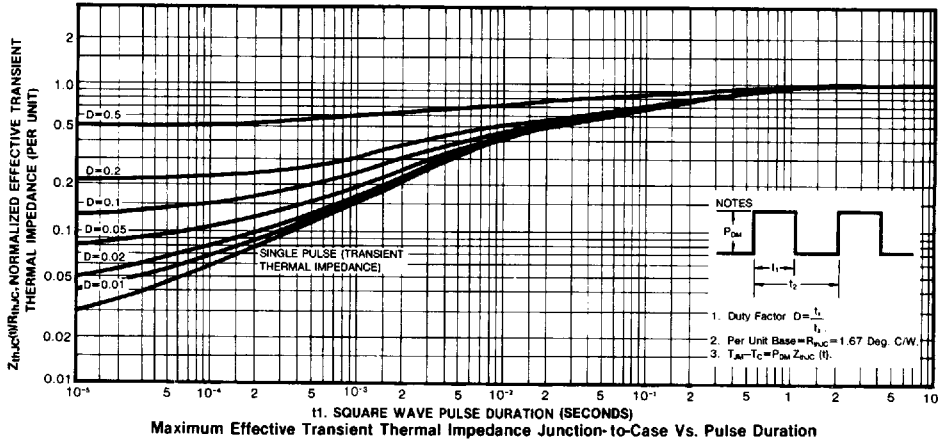
(3) Repetitive rating : Pulse width limited by max. junction temperature

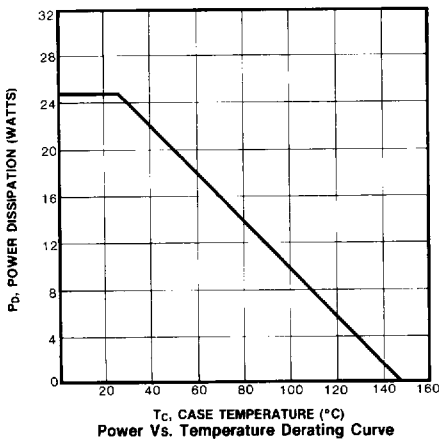
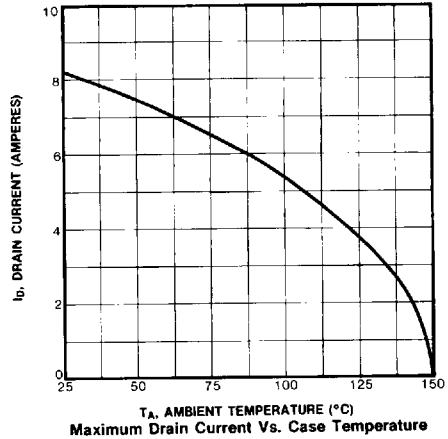
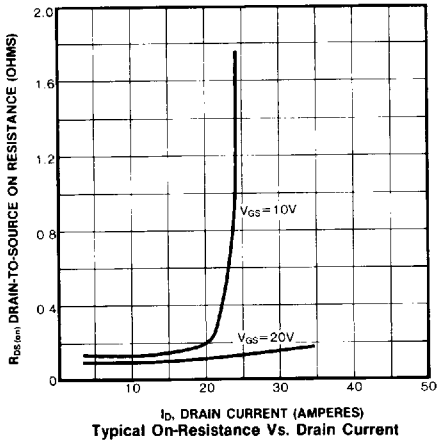
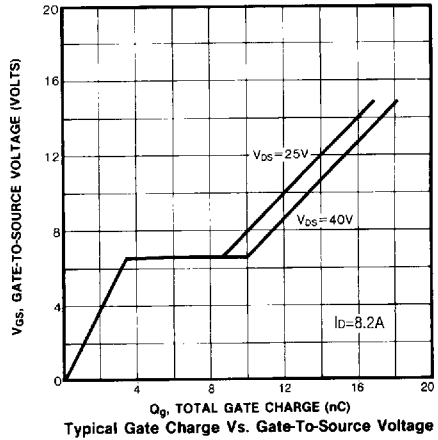
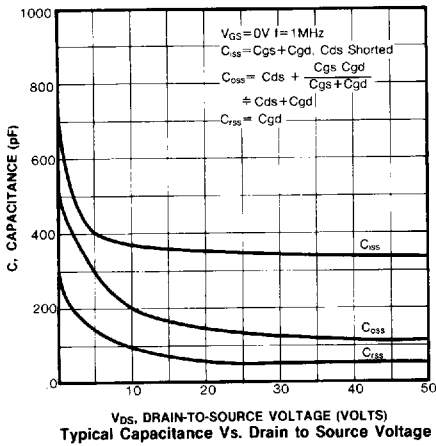
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
I_S	Continuous Source Current (Body Diode)	-	-	8.2	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier 
I_{SM}	Pulse Source Current (Body Diode) (3)	-	-	33	A	
V_{SD}	Diode Forward Voltage	-	-	1.6	V	$T_J=25^\circ\text{C}$, $I_S=8.2\text{A}$, $V_{GS}=0\text{V}$
t_{rr}	Reverse Recovery Time	-	-	190	ns	$T_J=25^\circ\text{C}$, $I_F=8.2\text{A}$, $dI_F/dt=100\text{A}/\mu\text{S}$

- Notes : (1) $T_J=25^\circ\text{C}$ to 150°C
 (2) Pulse test : Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
 (3) Repetitive rating : Pulse width limited by max. junction temperature







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